

LOAD SHARE CONTROLLER

FEATURES

- 2.7-V to 20-V Operation
- 8-Pin Package
- Requires Minimum Number of External Components
- Compatible with Existing Power Supply Designs Incorporating Remote Output Voltage Sensin
- Differential Share Bus
- Precision Current Sense Amplifier (40 Gain)
- UVLO (Undervoltage Lockout) Circuitry
- User Programmable Share Loop Compensation

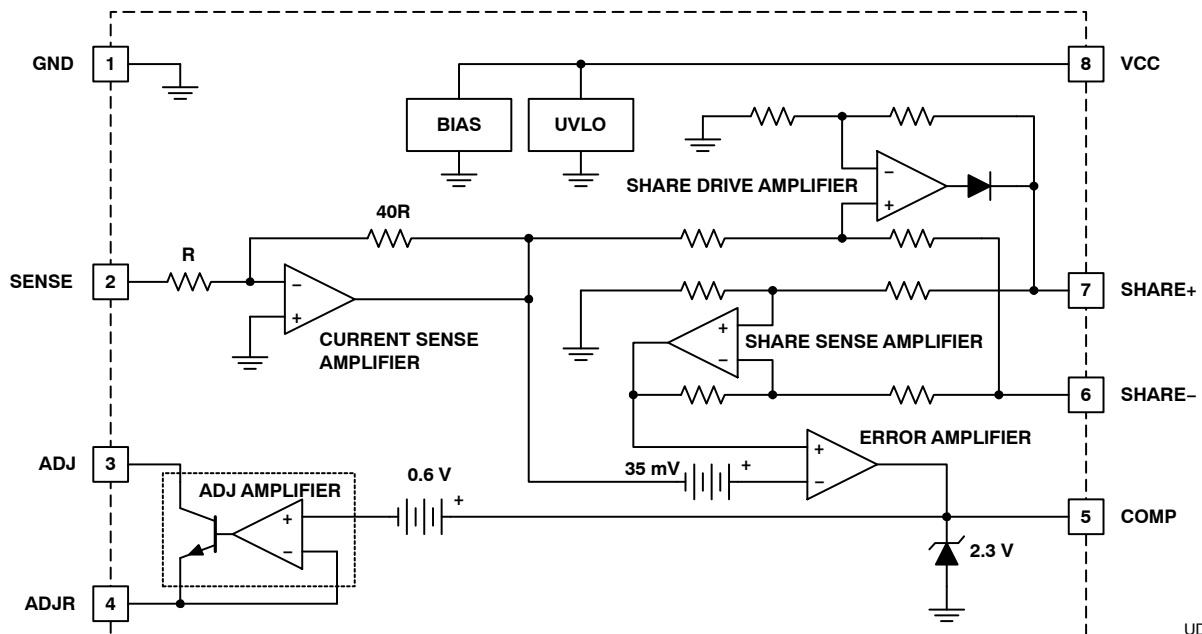
APPLICATIONS

- Paralleled Power Supplies

DESCRIPTION

The UC3902 load share controller is an 8-pin device that balances the current drawn from independent, paralleled power supplies. Load sharing is accomplished by adjusting each supplies' output current to a level proportional to the voltage on a share bus.

The master power supply, which is automatically designated as the supply that regulates to the highest voltage, drives the share bus with a voltage proportional to its output current. The UC3902 trims the output voltage of the other paralleled supplies so that they each support their share of the load current. Typically, each supply is designed for the same current level although that is not necessary for use with the UC3902. By appropriately scaling the current sense resistor, supplies with different output current capability can be paralleled with each supply providing the same percentage of their output current capability for a particular load.



UDG-01141

DESCRIPTION (continued)

A differential line is used for the share bus to maximize noise immunity and accommodate different voltage drops in each power converter’s ground return line. Trimming of each converter’s output voltage is accomplished by injecting a small current into the output voltage sense line, which requires a small resistance (typically 20 Ω to 100 Ω) to be inserted.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

| | | UC2902 UC3902 | UNIT |
|--|----------------|--------------------------------|-------------|
| Input voltage range, V _I | VCC, ADJ | -0.3 to 20 | V |
| | SENSE | -5 to 5 | |
| | ADJR, COMP | -0.3 to 4 | |
| | SHARE-, SHARE+ | -0.3 to 10 | |
| Output current, I _O | SHARE+ | -100 mA to 10 mA | mA |
| | ADJ | -1 mA to 30 mA | mA |
| Operating free-air temperature range, T _A | | -40 to 100 | °C |
| Junction temperature range, T _J | | -55 to 105 | |
| Storage temperature, T _{stg} | | -65 to 150 | |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | | 300 | |

⁽¹⁾ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. Voltages are with respect to GND. Currents are positive into, and negative out of the specified terminal.

ELECTRICAL CHARACTERISTICS

T_J = -40°C to 105°C, (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------------------|-----------------------------------|--|------|------|------|------|
| Power SUPPLY SUPPLY CURRENT | | | | | | |
| I _{CC} | Supply current | SHARE+ = 1 V, SENSE = 0 V | | 4 | 6 | mA |
| | | V _{CC} = 20 V | | 6 | 10 | |
| UNDERVOLTAGE LOCKOUT | | | | | | |
| V _{CC} | Startup voltage | SHARE+ = 0.2 V, SENSE = 0 V, COMP = 1 V | 2.3 | 2.5 | 2.7 | V |
| | Hysteresis | SHARE+ = 0.2 V, SENSE = 0 V, COMP = 1 V | 60 | 100 | 140 | mV |
| CURRENT SENSE AMPLIFIER | | | | | | |
| V _{IO} | Input offset voltage | 0.1 V ≤ V _(SHARE+) ≤ 1.1 V | -2.5 | -0.5 | 1.5 | mV |
| | SENSE to SHARE gain | 0.1 V ≤ V _(SHARE+) ≤ 1.1 V | -41 | -40 | -39 | V |
| R _{IN} | Input resistance | | 0.6 | 1 | 1.5 | V |
| SHARE DRIVE AMPLIFIER | | | | | | |
| V _{OH} | High-level output voltage, SHARE+ | V _{CC} = 2.5 V V _(SENSE) = -50 mV I _(SHARE+) = -1 mA | 1.2 | 1.4 | | V |
| | | V _{CC} = 12 V V _(SENSE) = -250 mV I _(SHARE+) = -1 mA | 9.6 | 10.0 | 10.4 | |
| | | V _{CC} = 20 V V _(SENSE) = -250 mV I _(SHARE+) = -1 mA | 9.6 | 10.0 | 10.4 | |
| V _{OL} | Low-level output voltage, SHARE+ | V _{CC} = 2.5 V V _(SENSE) = 10 mV I _(SHARE+) = -1 mA | | 20 | 50 | mV |
| | | V _{CC} = 12 V V _(SENSE) = 10 mV I _(SHARE+) = -1 mA | | 20 | 50 | |
| | | V _{CC} = 20 V V _(SENSE) = 10 mV I _(SHARE+) = -1 mA | | 20 | 50 | |
| V _O | Output voltage, SHARE+ | V _(SENSE) = 0 mV, R _(SHARE+) = 200 Ω (SHARE+ to GND) | | 20 | 40 | |
| CMRR | Common mode rejection ratio | 0 V ≤ V _(SHARE-) ≤ 1 V, SENSE used as input to amplifier | 50 | 90 | | dB |
| | Load regulation | Load on SHARE+, 1 mA ≤ I _{LOAD} ≤ -20 mA V _(SENSE) = -25 mV | | 0 | 20 | mV |
| I _{SC} | Short circuit current | V _(SHARE+) = 0 V, V _(SENSE) = -25 mV | -85 | -50 | -20 | mA |
| | Slew rate | V _(SENSE) = 10 mV to -90 mV step R _(SHARE+) = 200 Ω (SHARE+ to GND) | 0.12 | 0.26 | 0.38 | V/μs |
| | | V _(SENSE) = -90 mV to 10 mV step R _(SHARE+) = 200 Ω (SHARE+ to GND) | 0.12 | 0.26 | 0.38 | |

ELECTRICAL CHARACTERISTICS (continued)

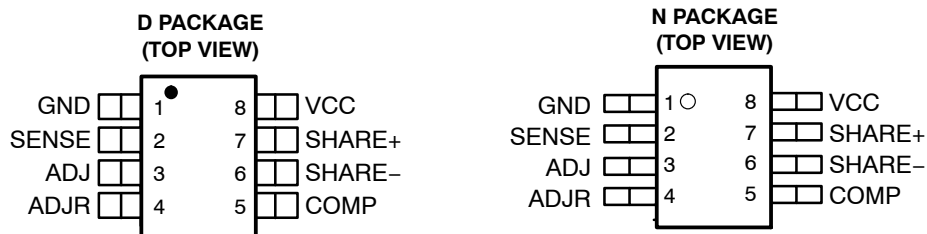
T_J = -40°C to 105°C, (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|------|------|------|------|
| SHARE SENSE AMPLIFIER | | | | | |
| R _{IN} Input impedance | V _(SHARE+) = 1 V, V _(SHARE-) = GND V _(SENSE) = 10 mV | 8 | 15 | | kΩ |
| | R _(SHARE+) = 200 Ω (SHARE+ to GND) V _(SHARE-) = 1 V, V _(SENSE) = 10 mV | 8 | 15 | | |
| V _(SHARE) Threshold voltage | V _(SENSE) = 0 V | 41 | 70 | 100 | mV |
| CMRR Common mode rejection ratio | 0 V ≤ V _(SHARE-) ≤ 1 V, V _(SENSE) = -2.5 mV | 50 | 60 | | dB |
| AVOL DESCRIPTION from SHARE+ to ADJR | V _(SENSE) = -2.5 mV, 5 nF capacitor from COMP to GND, 1 kΩ resistor from ADJR to GND | 50 | 68 | | |
| | V _(SENSE) = -2.5 mV, 5 nF capacitor from COMP to GND, 150 Ω resistor from ADJR to GND | 50 | 66 | | |
| Slew rate | V _(SHARE+) = 0 mV to 10 V step through a 200-Ω resistor, R _(COMP) = 500 Ω, V _(SENSE) = 10 mV, V _{CC} = 10 V | 0.2 | 0.5 | 0.8 | V/μs |
| ERROR AMPLIFIER | | | | | |
| g _M Transconductance, SHARE+ to COMP | 200-Ω resistor SHARE+ to GND | 3.0 | 4.5 | 6.0 | mS |
| I _{OH} High-level output current | V _(COMP) = 1.5 V, SHARE+ ≥ 300 mV V _(SENSE) = -10 mV | -450 | -325 | -200 | μA |
| I _{OL} Low-level output current | 200-Ω resistor SHARE+ to GND, V _(COMP) = 1.5 V, V _(SENSE) = 10 mV | 80 | 150 | 250 | |
| V _{IO} Input offset voltage | | 15 | 35 | 65 | mV |
| ΔV _{IO} / ΔV _(SENSE) | 1-kΩ resistor ADJR to GND -2.5 mV ≤ V _(SENSE) ≤ -25 mV | -6 | 0 | 6 | mV/V |
| ADJ AMPLIFIER | | | | | |
| ADJR low voltage | 200-Ω resistor SHARE+ to GND, V _(SENSE) = 10 mV | -1 | 0 | 1 | mV |
| ADJR high voltage | V _(SENSE) = 10 mV, V _(SHARE+) = 1 V | 1.4 | 1.8 | 2.1 | V |
| Current gain ADJR to ADJ | I _(ADJR) = -0.5 mA, V _(ADJ) = 2.5 V, V _(SENSE) = 10 mV, V _(SHARE+) = 1 V | 0.96 | 0.99 | 1.02 | A/A |
| | I _(ADJR) = -0.5 mA, V _(ADJ) = 20 V, V _(SENSE) = 10 mV, V _(SHARE+) = 1 V | 0.96 | 0.99 | 1.02 | |
| | I _(ADJR) = -10 mA, V _(ADJ) = 2.5 V, V _(SENSE) = 10 mV, V _(SHARE+) = 1 V | 0.96 | 0.99 | 1.02 | |
| | I _(ADJR) = -10 mA, V _(ADJ) = 20 V, V _(SENSE) = 10 mV, V _(SHARE+) = 1 V | 0.96 | 0.99 | 1.02 | |

ORDERING INFORMATION

| T _A | PACKAGE ⁽²⁾ | PART NUMBER |
|----------------|------------------------|-------------|
| -40°C to 85°C | SOIC (D) | UC2902D |
| | Plastic DIP (N) | UC2902N |
| 0°C to 70°C | SOIC (D) | UC3902D |
| | Plastic DIP (N) | UC3902N |

⁽²⁾ The D package is also available taped and reeled. Add an R suffix to the device type (i.e., bq24901DR) for quantities of 3,000 devices per reel.



TERMINAL FUNCTIONS

| TERMINAL | | I/O | DESCRIPTION |
|----------|-----|-----|--|
| NAME | NO. | | |
| ADJ | 3 | I | Current output of the adjust amplifier circuit (NPN collector) |
| ADJR | 4 | O | Current adjust amplifier range set (NPN emitter) |
| COMP | 5 | I/O | Output of the error amplifier, input of the adjust amplifier |
| GND | 1 | - | Local power supply return and signal ground |
| SENSE | 2 | I | Inverting input of the current sense amplifier |
| SHARE+ | 7 | I/O | Positive input from share bus or drive-to-share bus |
| SHARE- | 6 | I | Reference for SHARE+ pin |
| VCC | 8 | I | Local power supply (positive) |

APPLICATION INFORMATION

The values of five passive components must be determined to configure the UC3902 load share controller. The output and return lines of each converter are connected together at the load, with current sense resistor R_{SENSE} inserted in each negative return line. Another resistor, R_{ADJ} , is also inserted in each positive remote sense line. The differential share bus terminals (SHARE+ and SHARE-) of each UC3902 are connected together respectively, and the SHARE- node is also connected to the system ground. A typical application is illustrated in Figure 1.

The load share controller design can be executed by following the next few steps:

Step 1.

$$R_{SENSE} = \frac{V_{SHARE(max)}}{A_{CSA} \times I_{O(max)}} \quad (1)$$

- where A_{CSA} is 40, the gain of the current sense amplifier

At full load, the voltage drop across the R_{SENSE} resistor is $I_{O(max)} \times R_{SENSE}$. Taking into account the gain of the current sense amplifier, the voltage at full load on the current share bus,

$$V_{SHARE(max)} = \frac{A_{CSA} \times I_{O(max)}}{R_{SENSE}} \quad (2)$$

This voltage must stay 1.5-V below V_{CC} or below 10 V whichever is smaller. V_{SHARE} represents an upper limit but the designer should select the full scale share bus voltage keeping in mind that every volt on the load share bus increases the master controller's supply current by approximately 100 μ A times the number of slave units connected parallel.

Step 2.

$$R_G = \frac{V_{ADJ(max)}}{I_{ADJ(max)}} \quad (3)$$

Care must be taken to ensure that $I_{ADJ(max)}$ is low enough so that both the drive current and power dissipation are within the device's capability. For most applications, an $I_{ADJ(max)}$ current between 5 mA and 10 mA is acceptable. In a typical application, a 360- Ω R_G resistor from the ADJR pin to ground sets $I_{ADJ(max)}$ to approximately 5 mA.

Step 3.

$$R_{ADJ} = \frac{\Delta V_{O(max)} - (I_{O(max)} \times R_{SENSE})}{I_{ADJ(max)}} \quad (4)$$

R_{ADJ} must be low enough to not affect the normal operation of the converter's voltage feedback loop. Typical R_{ADJ} values are between 20 Ω to 100 Ω depending on V_O , $\Delta V_{O(max)}$ and the selected $I_{ADJ(max)}$ value.

Step 4.

$$C_C = \frac{g_M}{2\pi \times f_C} \times \frac{R_{ADJ}}{R_G} \times \frac{R_{SENSE}}{R_{LOAD}} \times A_{CSA} \times A_{PWR} (f_C) \quad (5)$$

The share loop compensation capacitor, C_C is calculated to produce the desired share loop unity gain crossover frequency, f_C . The share loop error amplifier's transconductance, g_M is nominally 4.5 ms. The values of the resistors are already known. Typically, f_C is set to at least one order of magnitude below the converter's closed loop bandwidth. The load share circuit is primarily intended to compensate for each converter's initial output voltage tolerance and temperature drift, not for differences in their transient response. The term $A_{PWR(f_C)}$ is the gain of the power supply measured at the desired share loop crossover frequency, f_C . This gain can be measured by injecting the measurement signal between the positive output and the positive sense terminal of the power supply.

Step 5.

$$R_C = \frac{1}{2\pi \times f_C \times C_C} \quad (6)$$

A resistor in series with C_C is required to boost the phase margin of the load share loop. The zero is placed at the load share loop crossover frequency, f_C .

When the system is powered up, the converter with the highest output voltage tends to source the most current and take control of the share bus. The other converters increase their output voltages until their output currents are proportional to the share bus voltage minus 50 mV. The converter which is functioning as the master may change due to warmup drift and differences in load and line transient response of each converter.

ADDITIONAL INFORMATION

Please refer to the following topic for additional application information.

1. Application Note U-163, (TI Literature No. SLUA128) *The UC3902 Load Share Controller and Its Performance in Distributed Power Systems* by Laszlo Balogh

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|---------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| UC2902D | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | UC2902D |
| UC2902D.A | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | UC2902D |
| UC2902DG4 | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | UC2902D |
| UC2902DTR | NRND | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | UC2902D |
| UC2902DTR.A | NRND | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | UC2902D |
| UC2902N | NRND | Production | PDIP (P) 8 | 50 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | UC2902N |
| UC2902N.A | NRND | Production | PDIP (P) 8 | 50 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | UC2902N |
| UC3902D | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | UC3902D |
| UC3902D.A | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | UC3902D |
| UC3902DG4 | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | UC3902D |
| UC3902DTR | NRND | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | UC3902D |
| UC3902DTR.A | NRND | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | UC3902D |
| UC3902N | NRND | Production | PDIP (P) 8 | 50 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | UC3902N |
| UC3902N.A | NRND | Production | PDIP (P) 8 | 50 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | UC3902N |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| UC2902DTR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| UC3902DTR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2902DTR | SOIC | D | 8 | 2500 | 353.0 | 353.0 | 32.0 |
| UC3902DTR | SOIC | D | 8 | 2500 | 353.0 | 353.0 | 32.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------|--------------|--------------|------|-----|--------|--------|--------|--------|
| UC2902D | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC2902D.A | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC2902DG4 | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC2902N | P | PDIP | 8 | 50 | 506 | 13.97 | 11230 | 4.32 |
| UC2902N.A | P | PDIP | 8 | 50 | 506 | 13.97 | 11230 | 4.32 |
| UC3902D | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC3902D.A | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC3902DG4 | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| UC3902N | P | PDIP | 8 | 50 | 506 | 13.97 | 11230 | 4.32 |
| UC3902N.A | P | PDIP | 8 | 50 | 506 | 13.97 | 11230 | 4.32 |



D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

- Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- This dimension does not include interlead flash.
- Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

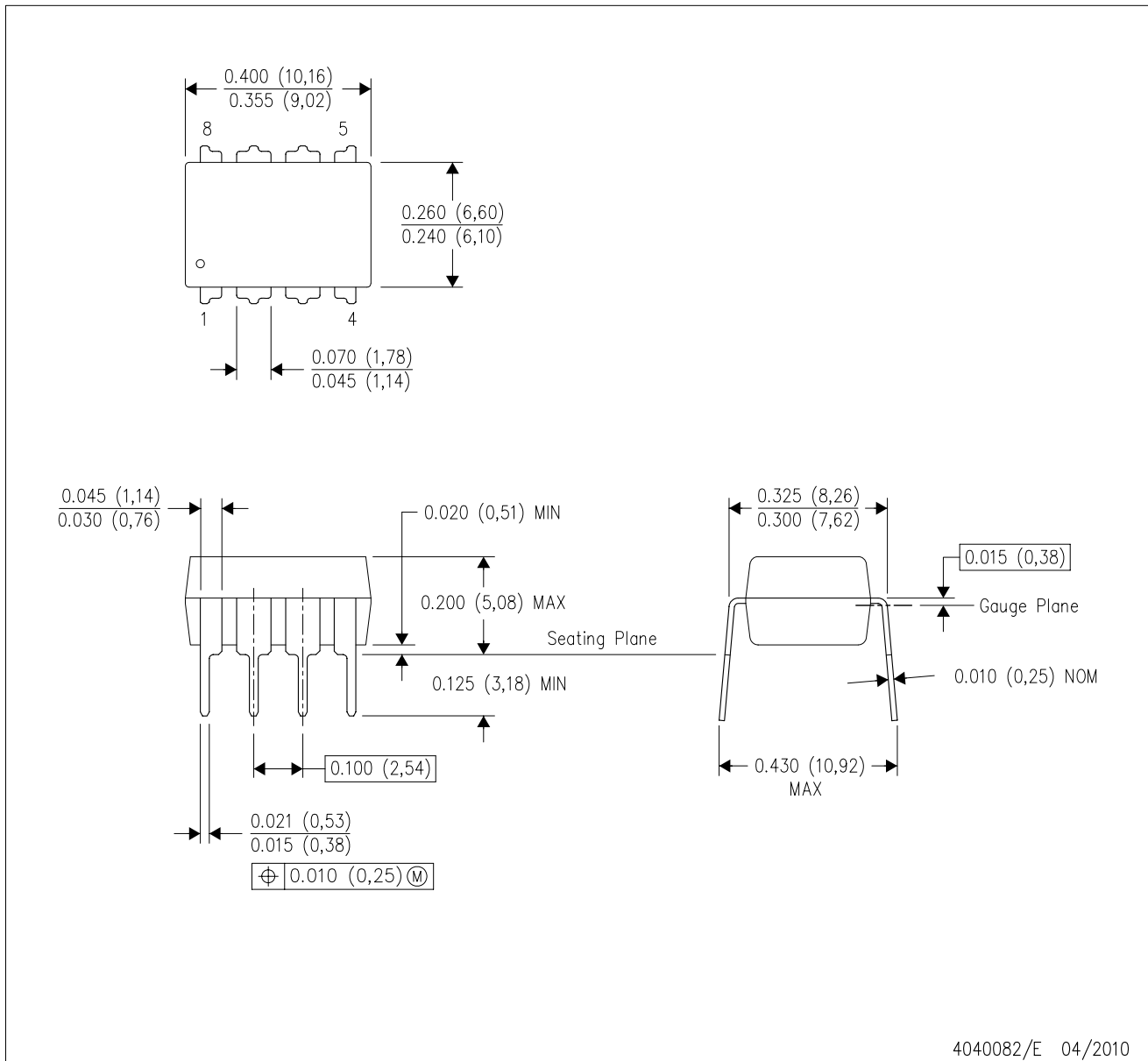
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/E 04/2010

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

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